

## Product Summary

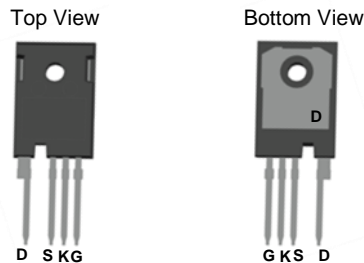
BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> T <sub>C</sub> = +25°C
1700V	0.85Ω @V <sub>GS</sub> = 20V	6.58A

## Description and Applications

This SiC MOSFET is designed to minimize the on-state resistance yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- SMPS (switching mode power supplies)
- UPS (uninterruptable power supplies)
- DC-DC converters for EV/HEV
- Auxiliary power supplies
- On-board chargers (OBC)

TO247-4 Standard




Pin Configuration

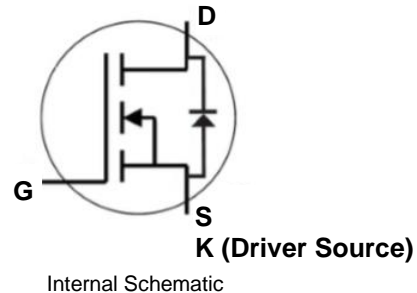
## Features and Benefits

- High Blocking Voltage with Low On-Resistance
- High BV<sub>DSS</sub> Rating for Power Application
- Low Input Capacitance
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- The DMWSH170H850HM4Q is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

<https://www.diodes.com/quality/product-definitions/>

## Mechanical Data

- Package: TO247-4
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Terminal Connections: See Diagram
- Terminals: Finish – Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 
- Weight: 6.6 grams (Approximate)

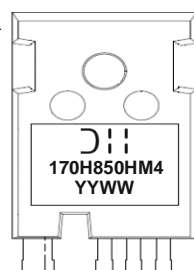


## Ordering Information (Note 4)

Orderable Part Number	Package	Packing	
		Qty.	Carrier
DMWSH170H850HM4Q	TO247-4 Standard	30 Pieces	Tube

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information



**DII** = Manufacturer's Marking  
**170H850HM4** = Product Type Marking Code  
**YYWW** or **YYWW** = Date Code Marking  
**YY** or **YY** = Last Two Digits of Year (ex: 25 = 2025)  
**WW** or **WW** = Week Code (01 to 53)

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	1700	V
Gate-Source Voltage	V <sub>GS(max)</sub>	-10/+25	V
Gate-Source Voltage (Recommended Operating Values)	V <sub>GS(op)</sub>	-5/+20	V
Continuous Drain Current (Notes 5, 9)	I <sub>D</sub>	T <sub>C</sub> = +25°C 6.58 T <sub>C</sub> = +100°C 4.65	A
Continuous Diode Forward Current (Note 5)	I <sub>S</sub>	11	A
Pulsed Source Current (10μs Pulse, Duty Cycle = 1%) (Note 5)	I <sub>SM</sub>	11	A
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%) (Note 5)	I <sub>DM</sub>	19	A

**Thermal Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P <sub>D</sub>	T <sub>C</sub> = +25°C 73.5 T <sub>C</sub> = +100°C 36.6	W
Thermal Resistance, Junction to Ambient (Note 6)	R <sub>θJA</sub>	30.7	°C/W
Thermal Resistance, Junction to Case (Note 5)	R <sub>θJC</sub>	2.04	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +175	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	1700	—	—	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = 100μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	—	—	100	μA	V <sub>D</sub> = 1700V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	—	—	±250	nA	V <sub>GS</sub> = +20/-10V, V <sub>D</sub> = 0V
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	2.0	2.8	4.0	V	V <sub>D</sub> = V <sub>GS</sub> , I <sub>D</sub> = 0.5mA
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	—	0.63	0.85	Ω	V <sub>GS</sub> = 20V, I <sub>D</sub> = 2A
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	—	0.68	—	Ω	V <sub>GS</sub> = 18V, I <sub>D</sub> = 2A
Diode Forward Voltage	V <sub>SD</sub>	—	3.8	—	V	V <sub>GS</sub> = -5V, I <sub>S</sub> = 1A
Transconductance	g <sub>fs</sub>	—	60	—	S	V <sub>D</sub> = 20V, I <sub>D</sub> = 2A
DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance	C <sub>iss</sub>	—	178	—	pF	V <sub>GS</sub> = 0V, V <sub>D</sub> = 1000V, V <sub>AC</sub> = 25mV, f = 1MHz
Output Capacitance	C <sub>oss</sub>	—	11	—		
Reverse Transfer Capacitance	C <sub>rss</sub>	—	1.1	—		
C <sub>oss</sub> Stored Energy	E <sub>oss</sub>	—	7.1	—	μJ	V <sub>GS</sub> = -5V/+20V, V <sub>D</sub> = 1.2kV, R <sub>g</sub> = 2.5Ω, I <sub>D</sub> = 2A, L = 1.4mH
Turn-On Switching Energy (Body Diode Forward)	E <sub>ON</sub>	—	56	—	μJ	
Turn-Off Switching Energy (Body Diode Forward)	E <sub>OFF</sub>	—	31	—		
Gate Resistance	R <sub>g</sub>	—	5.1	—	Ω	V <sub>AC</sub> = 25mV, f = 1MHz, I <sub>D</sub> = 0A
Total Gate Charge	Q <sub>g</sub>	—	14.8	—	nC	V <sub>GS</sub> = -5V/+20V, V <sub>D</sub> = 1.2kV, I <sub>D</sub> = 2A
Gate-Source Charge	Q <sub>gs</sub>	—	3.0	—		
Gate-Drain Charge	Q <sub>gd</sub>	—	6.3	—		
Turn-On Delay Time	t <sub>D(ON)</sub>	—	6.4	—	ns	V <sub>GS</sub> = -5V/+20V, V <sub>DD</sub> = 1.2kV, R <sub>g</sub> = 2.5Ω, I <sub>D</sub> = 2A, R <sub>L</sub> = 600Ω
Turn-On Rise Time	t <sub>R</sub>	—	11.4	—		
Turn-Off Delay Time	t <sub>D(OFF)</sub>	—	9.2	—		
Turn-Off Fall Time	t <sub>F</sub>	—	68	—		
Body Diode Reverse-Recovery Time	t <sub>RR</sub>	—	40	—	ns	V <sub>GS</sub> = -5V, V <sub>D</sub> = 1000V, I <sub>D</sub> = 20A, di/dt = 1000A/μs
Body Diode Reverse-Recovery Charge	Q <sub>R</sub>	—	59	—	nC	
Body Diode Reverse-Recovery Current	I <sub>RRM</sub>	—	2.2	—	A	

- Notes:
- Device mounted on an infinite heatsink.
  - Device mounted on FR-4 substrate PC board, 2oz. copper, with minimum recommended pad layout.
  - Guaranteed by design. Not subject to production testing.
  - Short duration pulse test used to minimize self-heating effect.
  - Drain current limited by maximum junction temperature.

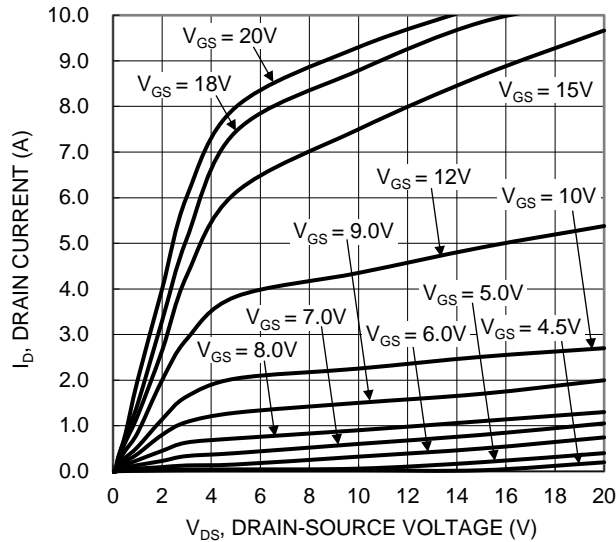


Figure 1. Typical Output Characteristic

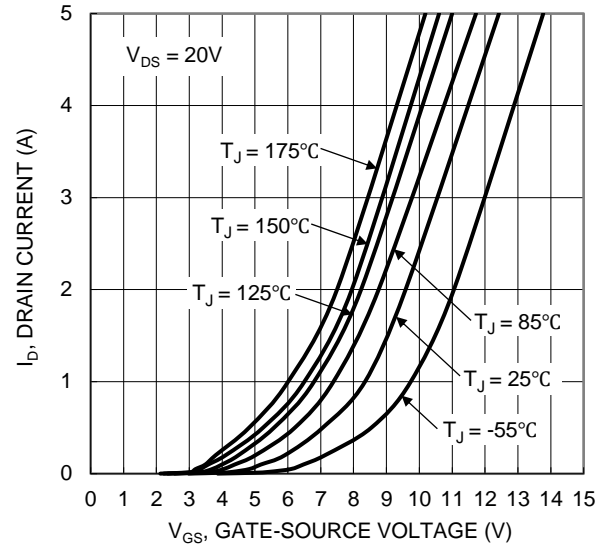


Figure 2. Typical Transfer Characteristic

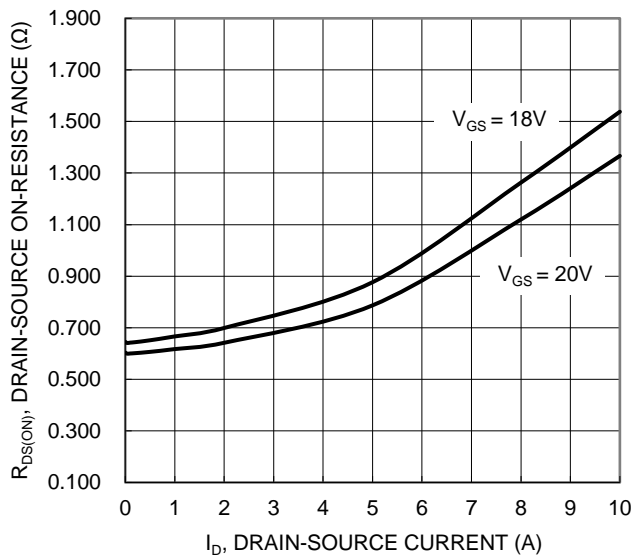


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

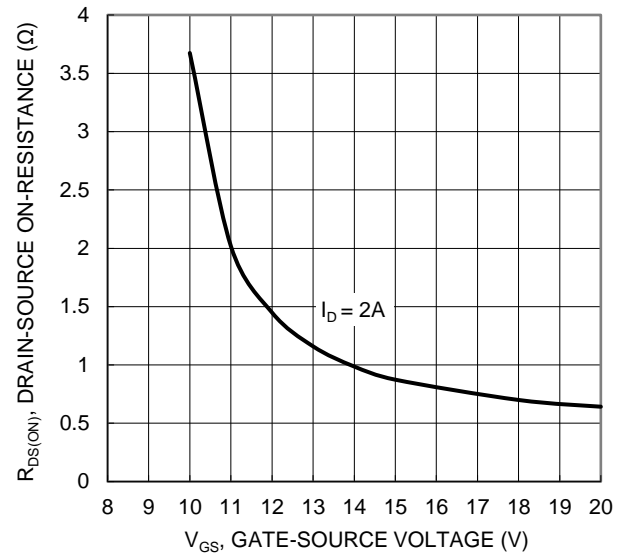


Figure 4. Typical Transfer Characteristic

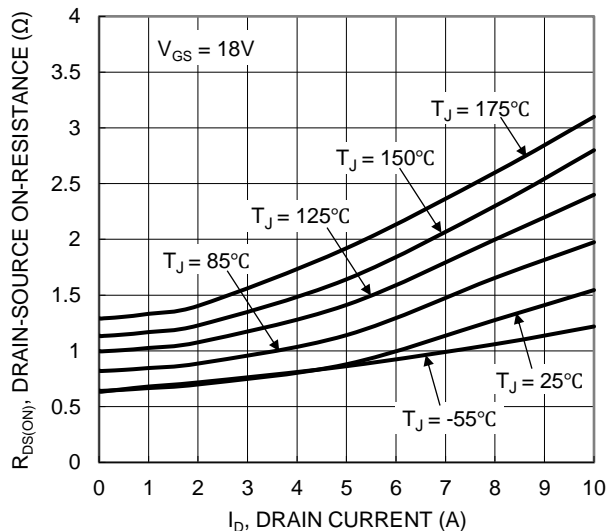


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

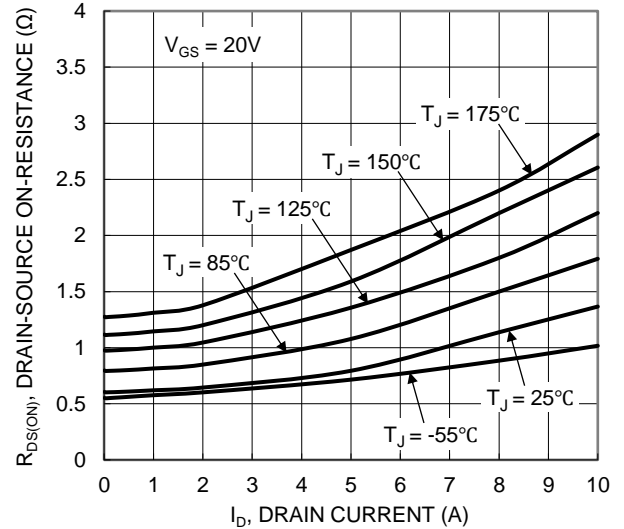
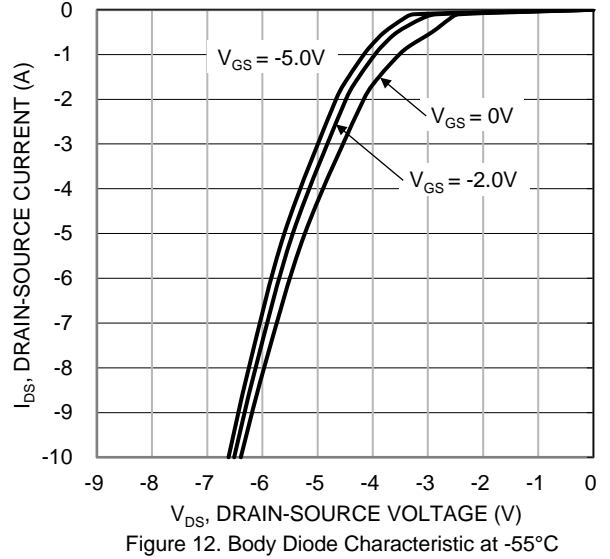
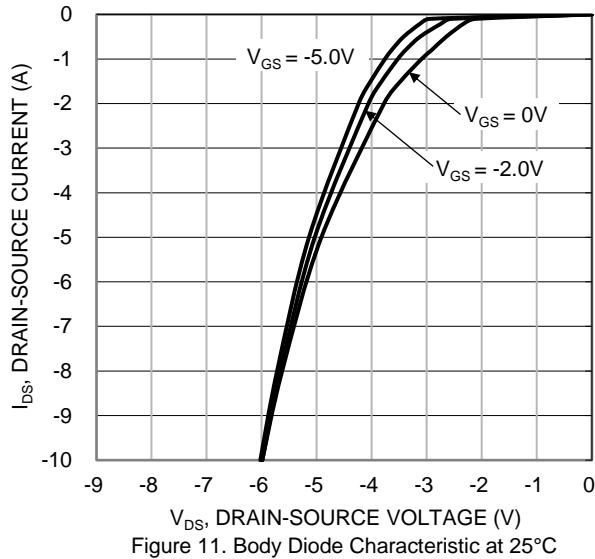
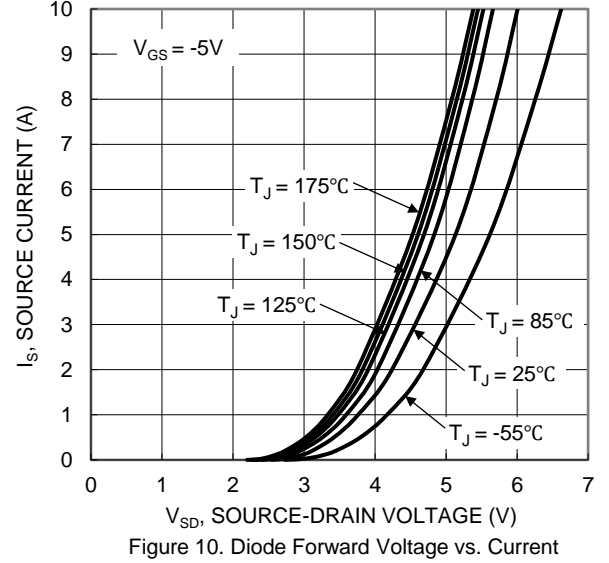
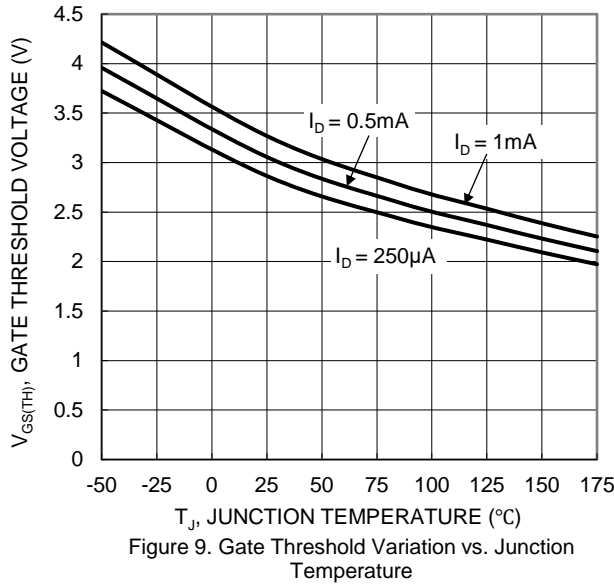
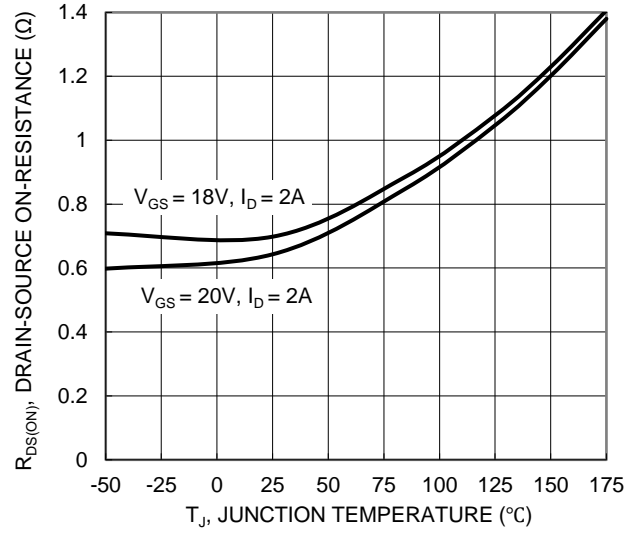
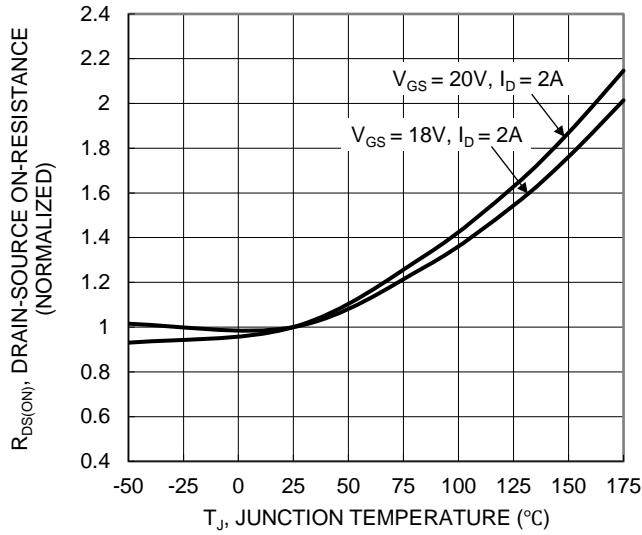
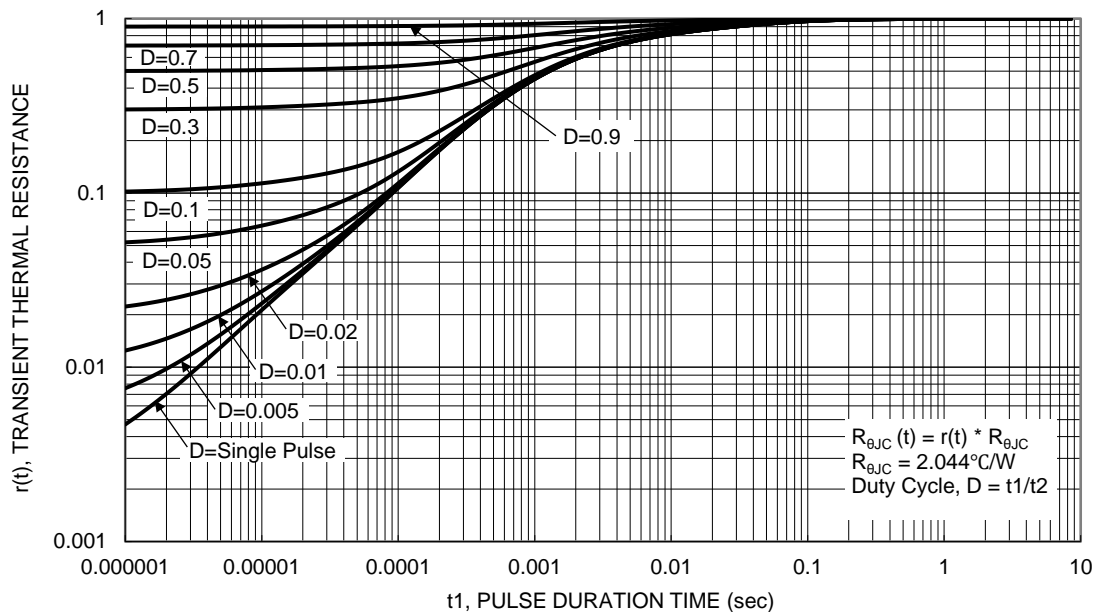
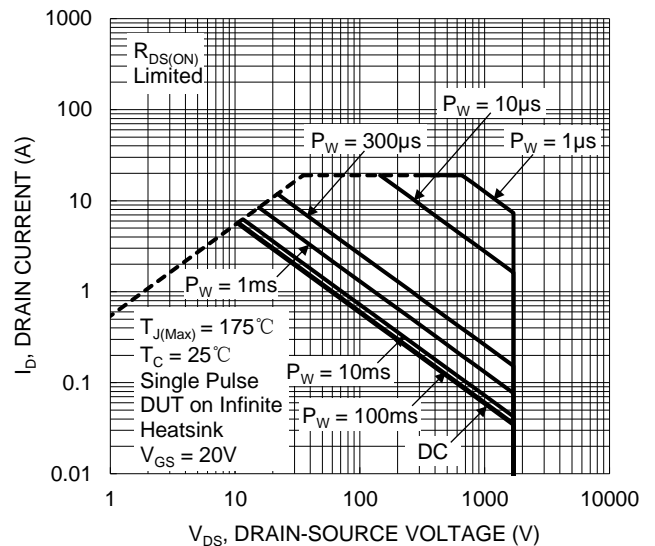
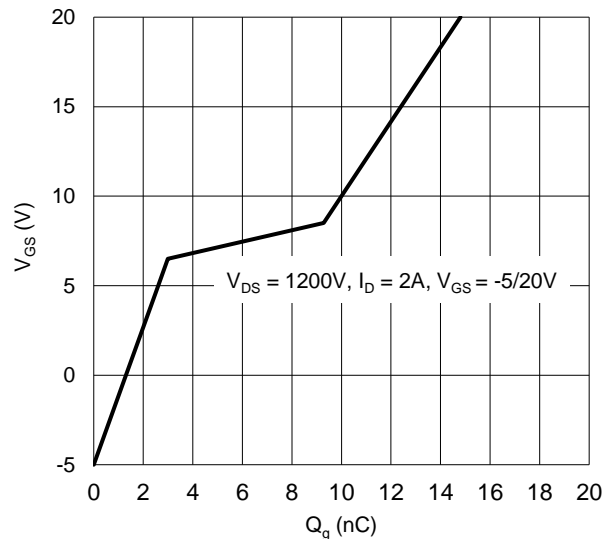
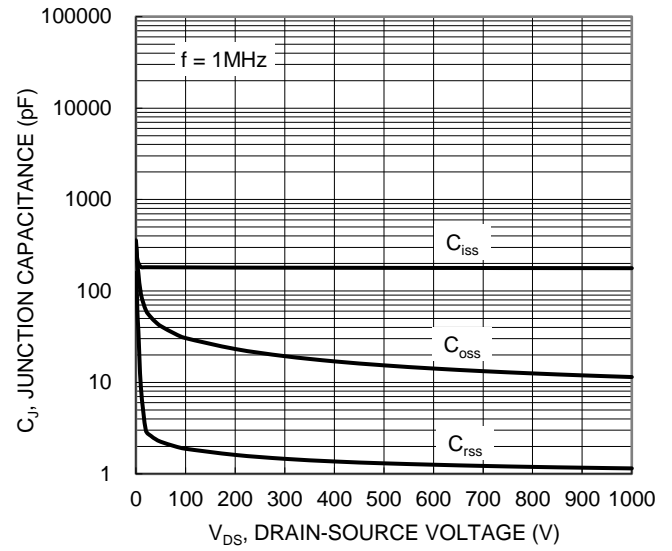
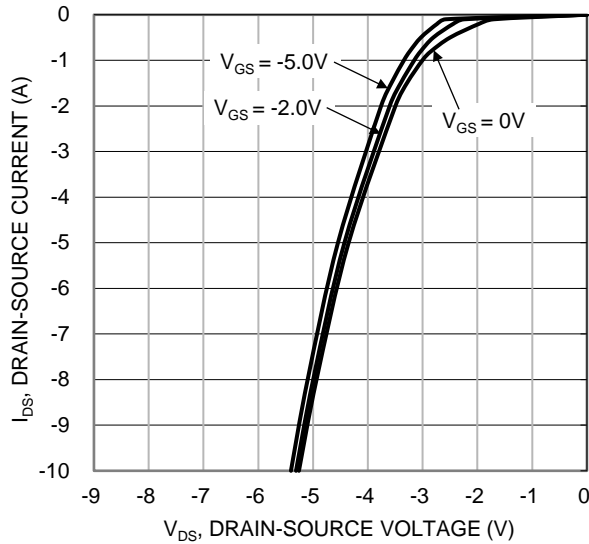


Figure 6. Typical On-Resistance vs. Drain Current and Temperature

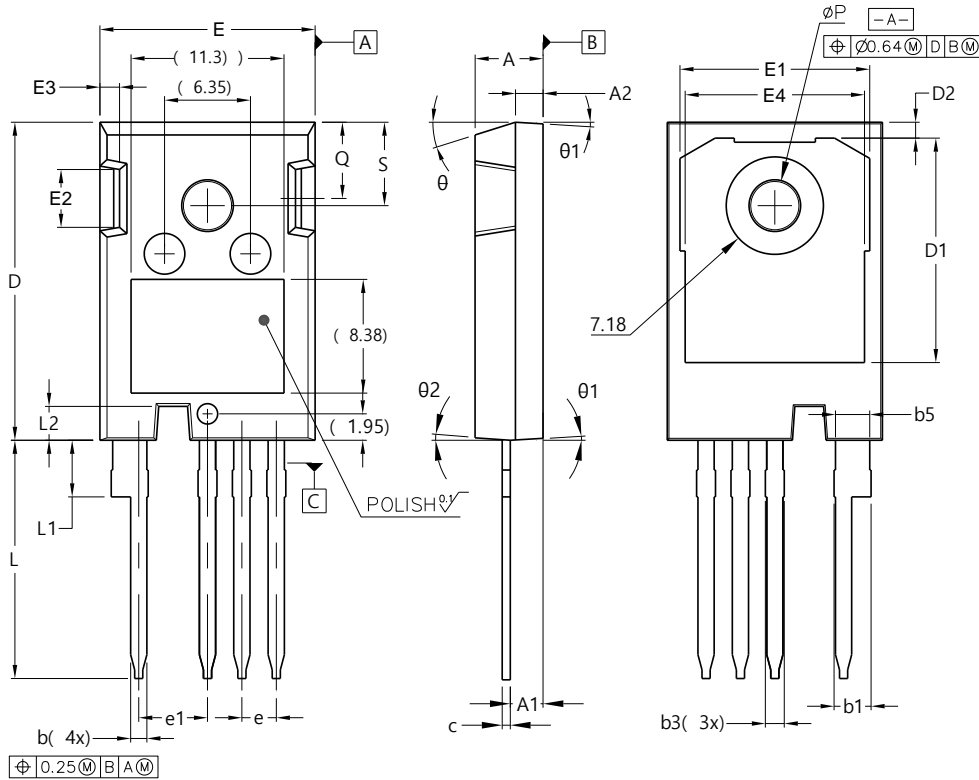




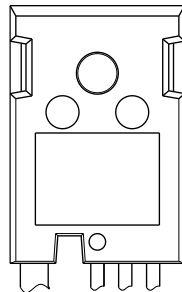
## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

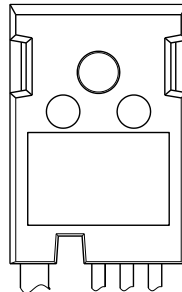
### TO247-4 Standard



TO247-4 Standard		
Dim	Min	Max
A	4.83	5.21
A1	2.29	2.54
A2	1.91	2.16
b	1.07	1.33
b1	2.39	2.94
b3	1.07	1.60
b5	2.39	2.69
c	0.55	0.68
D	23.30	23.60
D1	16.25	17.65
D2	0.95	1.25
E	15.75	16.30
E1	13.10	14.15
E2	3.68	5.10
E3	1.00	1.90
E4	12.38	13.43
e	2.54 BSC	
e1	5.08 BSC	
L	17.31	17.82
L1	3.97	4.37
L2	2.35	2.65
ØP	3.51	3.65
Q	5.49	6.00
S	6.04	6.30
θ	17.5°- 20° REF	
θ1	3.5°- 5° REF	
θ2	4°- 5° REF	
All Dimensions in mm		



OPTION A  
(TOP VIEW)



OPTION B  
(TOP VIEW)

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